FAIRCHILD SEMICONDUCTOR®

February 2012

FODM121 Series, FODM124, FODM2701, FODM2705
4-Pin Full Pitch Mini-Flat Package Transistor Output Optocouplers

Features

- More than 5mm creepage/clearance
- Compact 4-pin surface mount package (2.4mm maximum standoff height)
- Current Transfer Ratio in selected groups
  DC Input:
  FODM121: 50–600%
  FODM121A: 100–300%
  FODM121B: 50–150%
  FODM121C: 100–200%
  FODM2701: 50–300%
  FODM124: 100% MIN
  AC Input:
  FODM2705: 50–300%
- Available in tape and reel quantities of 2500
- Applicable to Infrared Ray reflow (260°C max, 10 sec.)
- C-UL, UL and VDE* certifications

*option 'V' required

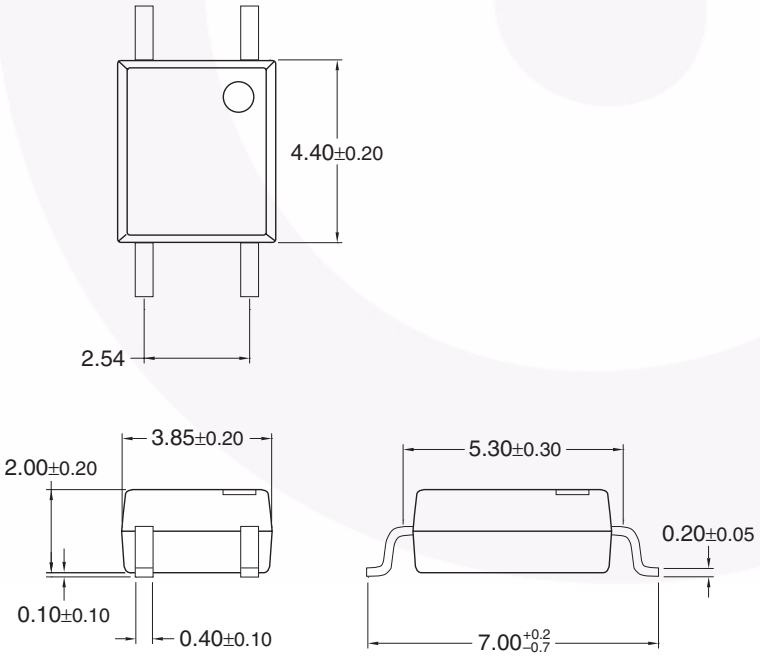
Applications

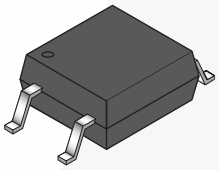
- Digital logic inputs
- Microprocessor inputs
- Power supply monitor
- Twisted pair line receiver
- Telephone line receiver

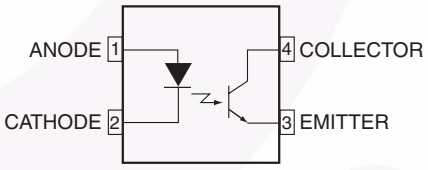
Description

The FODM124, FODM121 series, and FODM2701 consists of a gallium arsenide infrared emitting diode driving a phototransistor in a compact 4-pin mini-flat package. The lead pitch is 2.54mm. The FODM2705 consists of two gallium arsenide infrared emitting diodes connected in inverse parallel for AC operation.

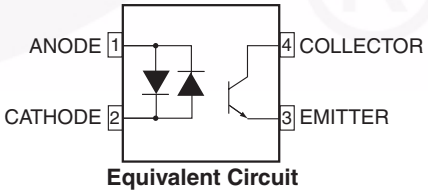
Package Dimensions







Equivalent Circuit
FODM121, FODM124, FODM2701



Equivalent Circuit
FODM2705

Note:
All dimensions are in millimeters.

Absolute Maximum Ratings (T_A = 25°C unless otherwise specified)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Value	Units
TOTAL PACKAGE				
T_{STG}	Storage Temperature		-40 to +125	°C
T_{OPR}	Operating Temperature		-40 to +110	°C
EMITTER				
$I_{F\ (avg)}$	Continuous Forward Current		50	mA
$I_{F\ (pk)}$	Peak Forward Current (1µs pulse, 300 pps.)		1	A
V_R	Reverse Input Voltage		6	V
P_D	Power Dissipation		70	mW
	Derate linearly (above 25°C)		0.65	mW/°C
DETECTOR				
	Continuous Collector Current		80	mA
P_D	Power Dissipation		150	mW
	Derate linearly (above 25°C)		2.0	mW/°C
V_{CEO}	Collector-Emitter Voltage	FODM2701, FODM2705	40	V
		FODM121 Series, FODM124	80	
V_{ECO}	Emitter-Collector Voltage		7	V

Electrical Characteristics (T_A = 25°C)

Individual Component Characteristics

Symbol	Parameter	Test Conditions	Device	Min.	Typ.*	Max.	Unit
EMITTER							
V_F	Forward Voltage	I_F = 10mA	FODM121 Series, FODM124	1.0		1.3	V
		I_F = 5mA	FODM2701			1.4	
		I_F = ±5mA	FODM2705				
I_R	Reverse Current	V_R = 5V	FODM2701			5	µA
			FODM121 Series				
			FODM124				
DETECTOR							
BV_{CEO}	Breakdown Voltage Collector to Emitter	I_C = 1mA, I_F = 0	FODM121 Series, FODM124	80			V
			FODM2701, FODM2705	40			
BV_{ECO}	Emitter to Collector	I_E = 100µA, I_F = 0	All	7			V
I_{CEO}	Collector Dark Current	V_{CE} = 40V, I_F = 0	All			100	nA
C_{CE}	Capacitance	V_{CE} = 0V, f = 1MHz	All		10		pF

Electrical Characteristics (Continued) (T_A = 25°C)

Transfer Characteristics

Symbol	Characteristic	Test Conditions	Device	Min.	Typ.*	Max.	Unit
CTR	DC Current Transfer Ratio	I_F = ±5mA, V_{CE} = 5V	FODM2705	50		300	%
		I_F = 5mA, V_{CE} = 5V	FODM2701	50		300	
		I_F = 5mA, V_{CE} = 5V	FODM121	50		600	
			FODM121A	100		300	
			FODM121B	50		150	
			FODM121C	100		200	
		I_F = 1mA, V_{CE} = 0.5V	FODM124	100		1200	
		I_F = 0.5mA, V_{CE} = 1.5V		50			
	CTR Symmetry	I_F = ±5mA, V_{CE} = 5V	FODM2705	0.3		3.0	
$V_{CE\ (SAT)}$	Saturation Voltage	I_F = ±10mA, I_C = 2mA	FODM2705			0.3	V
		I_F = 10mA, I_C = 2mA	FODM2701			0.3	
		I_F = 8mA, I_C = 2.4mA	FODM121 Series			0.4	
		I_F = 1mA, I_C = 0.5mA	FODM124			0.4	
t_r	Rise Time (Non-Saturated)	I_C = 2mA, V_{CE} = 5V, R_L = 100Ω	All		3		µs
t_f	Fall Time (Non-Saturated)	I_C = 2mA, V_{CE} = 5V, R_L = 100Ω	All		3		µs

Isolation Characteristics

Characteristic	Test Conditions	Symbol	Device	Min.	Typ.*	Max.	Unit
Steady State Isolation Voltage[1]	1 Minute	V_{ISO}	All	3750			VRMS

*All typicals at T_A = 25°C

Note:

1. Steady state isolation voltage, V_{ISO}, is an internal device dielectric breakdown rating. For this test, pins 1 and 2 are common, and pins 3 and 4 are common.

Typical Performance Curves

Fig. 1 Forward Current vs. Forward Voltage

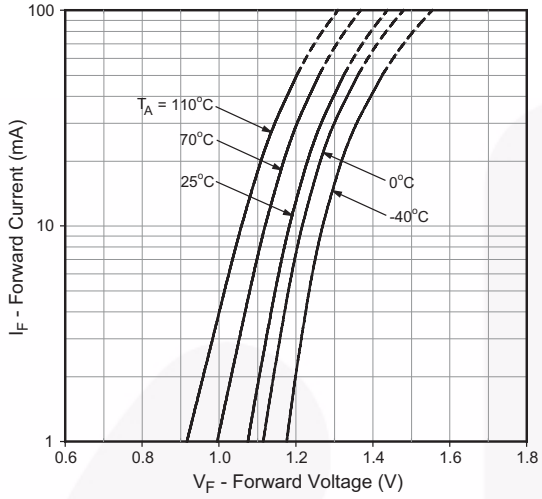


Fig. 2 Collector-Emitter Saturation Voltage vs. Ambient Temperature (FODM121/2701/2705)

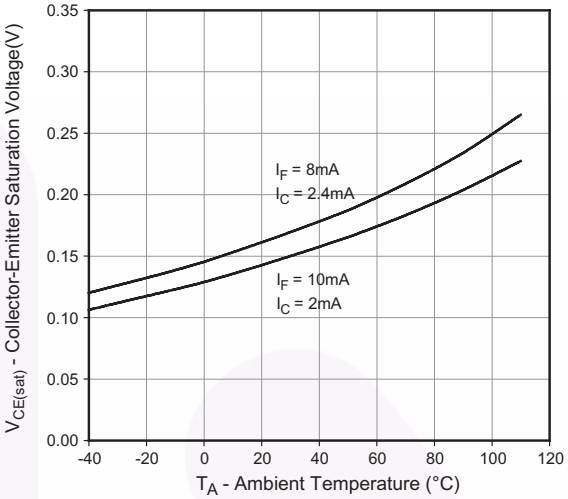


Fig. 3 Current Transfer Ratio vs. Forward Current (FODM121/2701/2705)

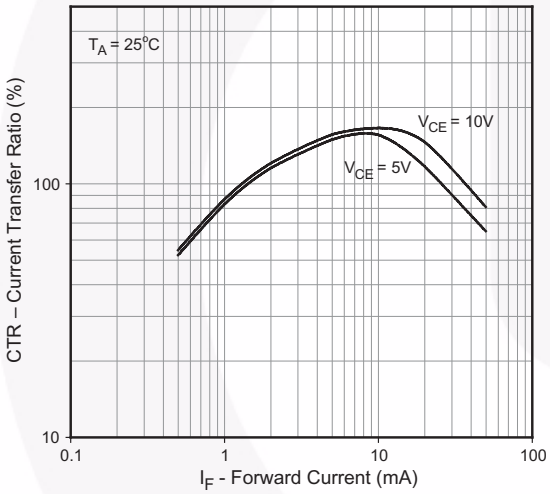


Fig. 4 Collector Current vs. Forward Current (FODM121/2701/2705)

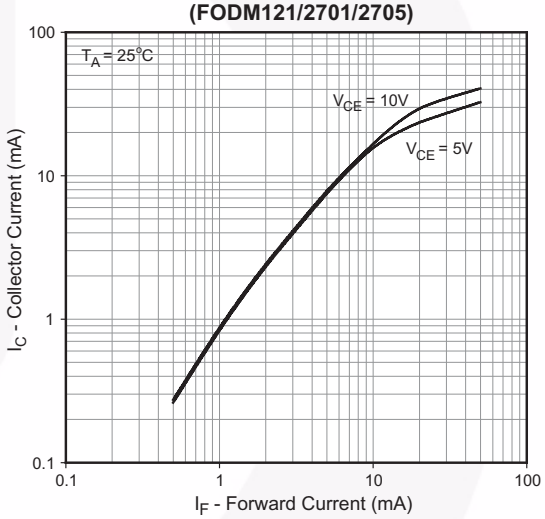


Fig. 5 Collector Current vs. Ambient Temperature (FODM121/2701/2705)

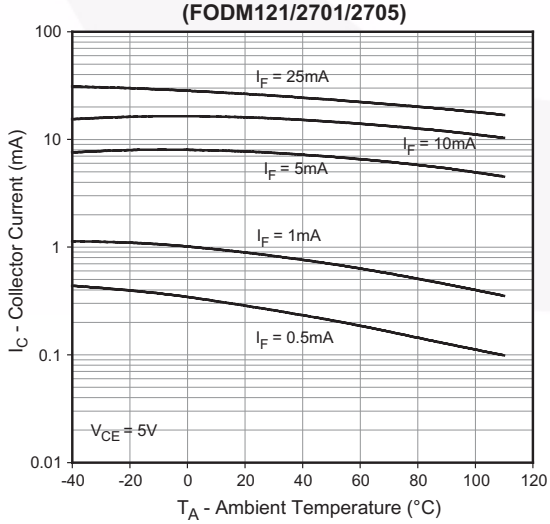


Fig. 6 Collector Current vs. Collector-Emitter Voltage (FODM121/2701/2705)

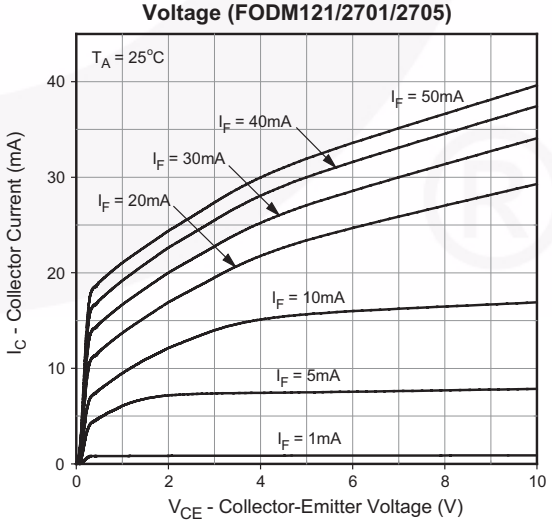


Fig 7. Collector Dark Current vs. Ambient Temperature (FODM121/2701/2705)

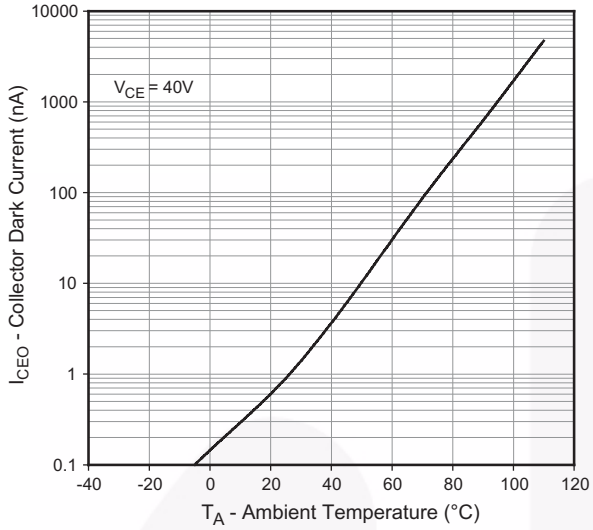


Fig. 8 Normalized Current Transfer Ratio vs. Ambient Temperature (FODM121/2701/2705)

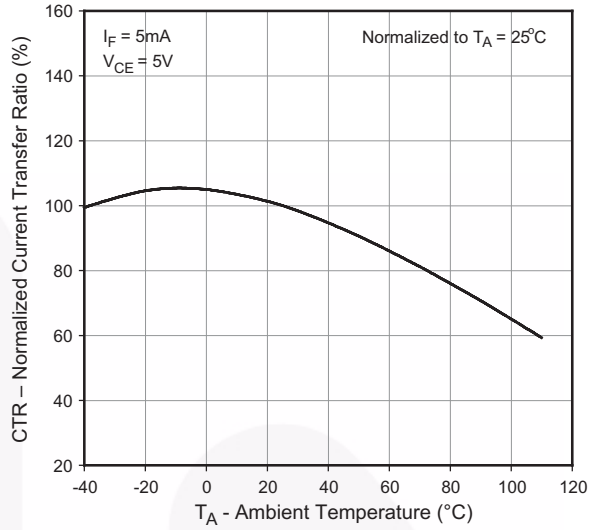


Fig. 9 Switching Time vs. Load Resistance (FODM121/2701/2705)

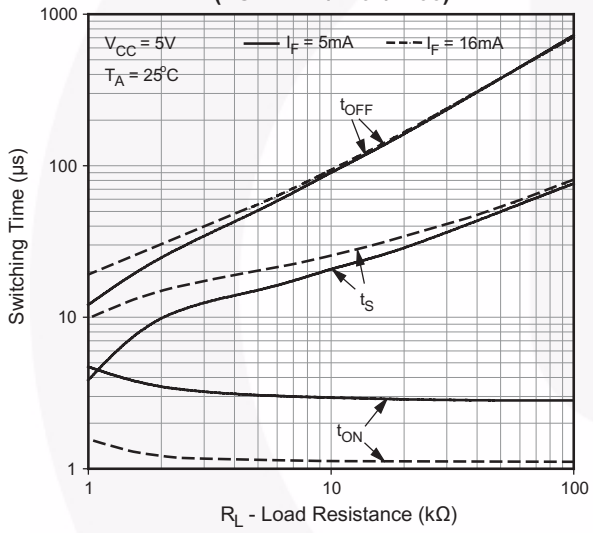


Fig. 10 Collector-Emitter Saturation Voltage vs. Ambient Temperature (FODM124)

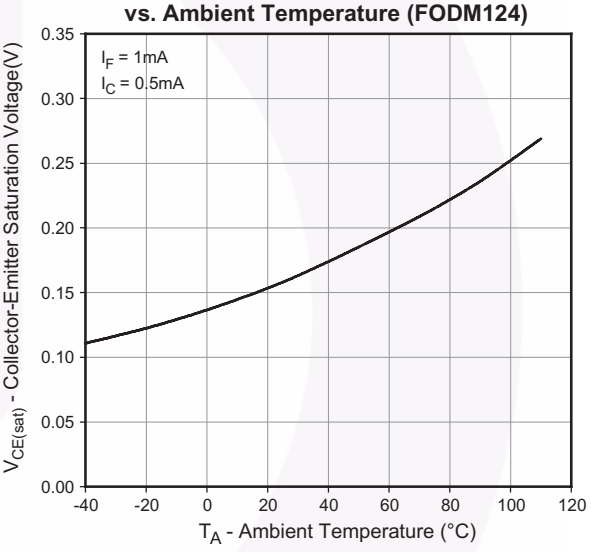


Fig. 11 Current Transfer Ratio vs. Forward Current (FODM124)

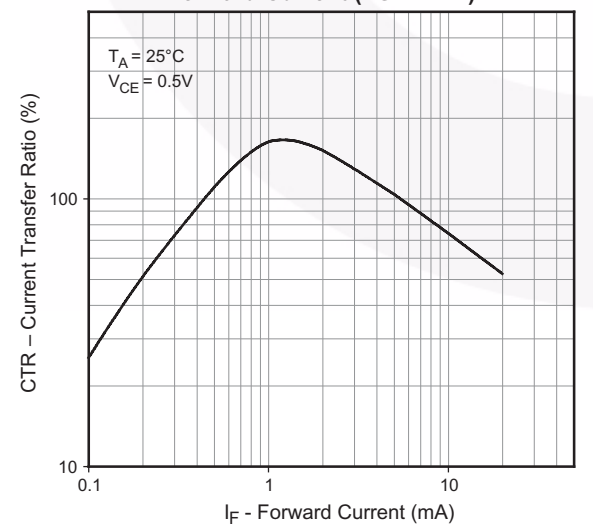


Fig 12. Collector Current vs. Forward Current (FODM124)

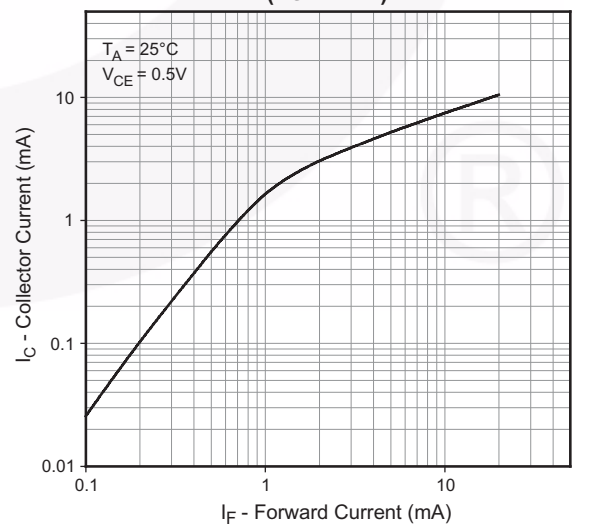


Fig 13. Collector Current vs. Ambient Temperature (FODM124)

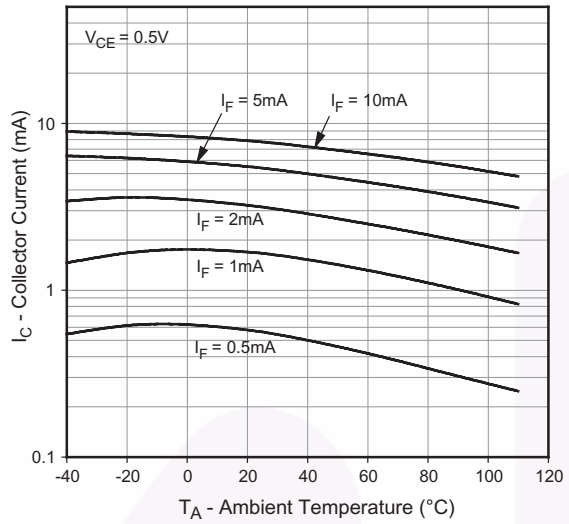


Fig. 14 Collector Current vs. Collector-Emitter Voltage (FODM124)

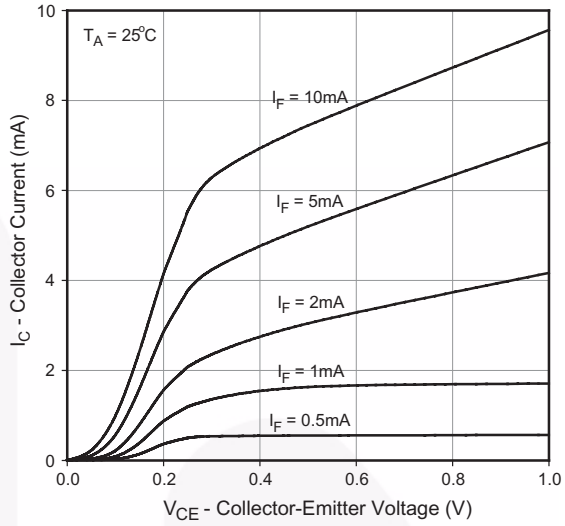


Fig. 15 Collector Dark Current vs. Ambient Temperature (FODM124)

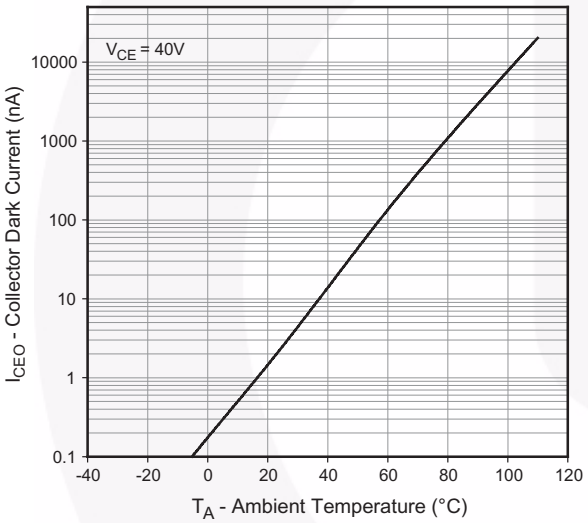


Fig. 16 Normalized Current Transfer Ratio vs. Ambient Temperature (FODM124)

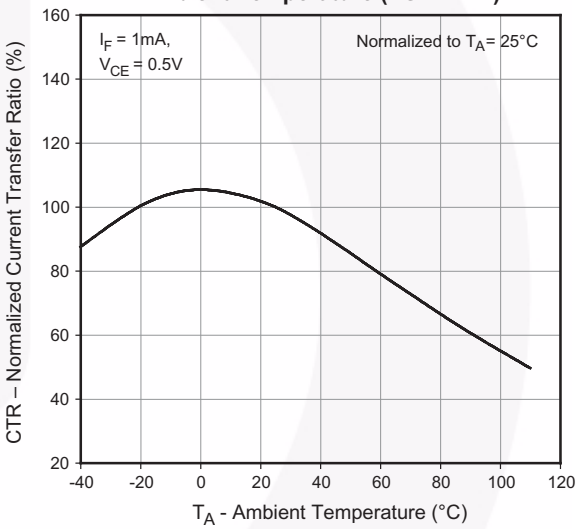
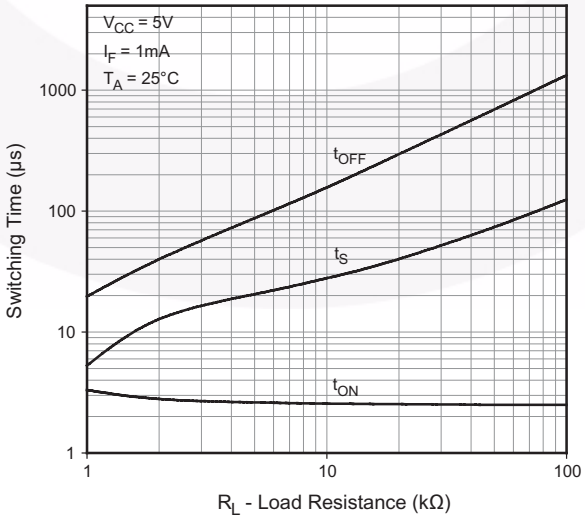


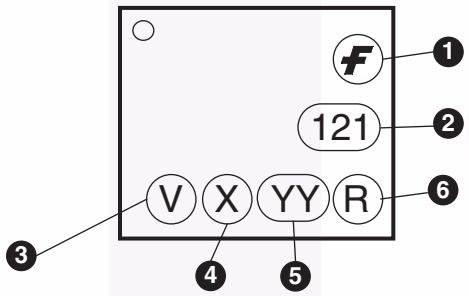
Fig. 17 Switching Time vs. Load Resistance (FODM124)



Ordering Information

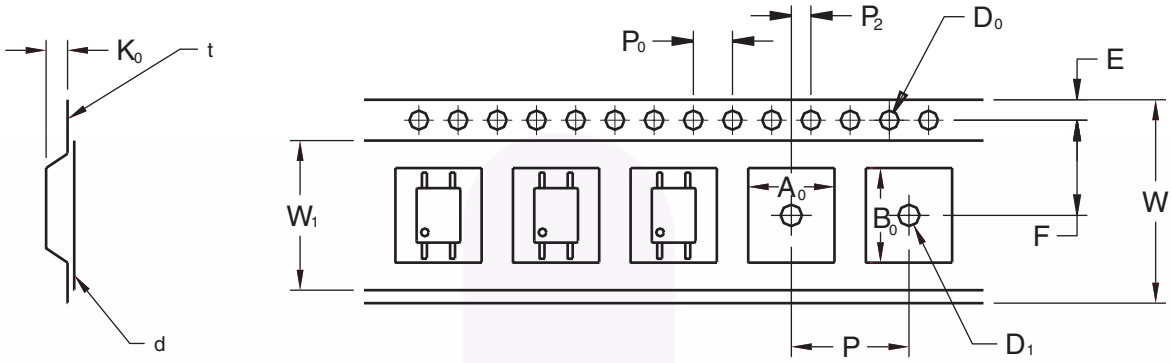
Option	Description
V	VDE Approved
R2	Tape and Reel (2500 units)
R2V	Tape and Reel (2500 units) and VDE Approved

Marking Information



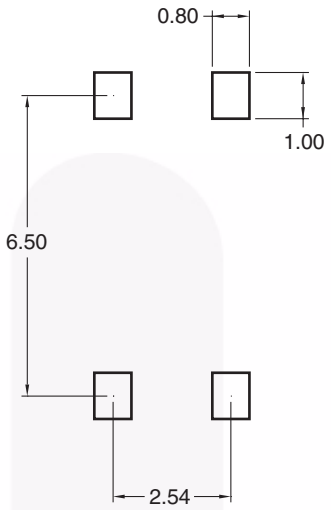
Definitions	
1	Fairchild logo
2	Device number
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)
4	One digit year code
5	Two digit work week ranging from ‘01’ to ‘53’
6	Assembly package code

Carrier Tape Specifications



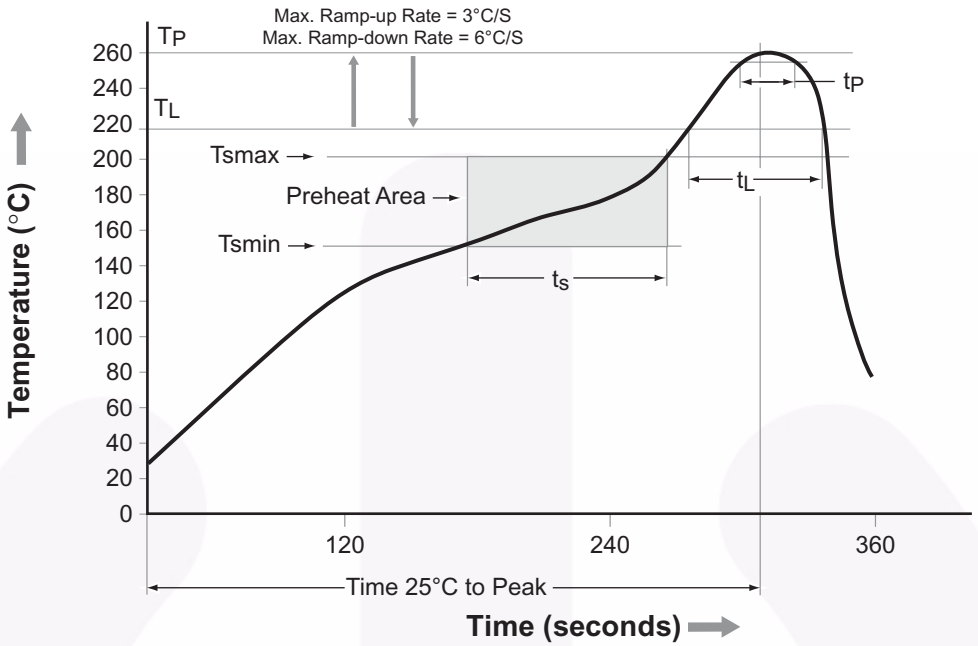
Description	Symbol	2.54 Pitch Dimensions
Tape Width	W	12.00±0.4
Tape Thickness	t	0.35±0.02
Sprocket Hole Pitch	P_0	4.00±0.20
Sprocket Hole Dia.	D_0	1.55±0.20
Sprocket Hole Location	E	1.75±0.20
Pocket Location	F	5.50±0.20
	P_2	2.00±0.20
Pocket Pitch	P	8.00±0.20
Pocket Dimension	A_0	4.75±0.20
	B_0	7.30±0.20
	K_0	2.30±0.20
Pocket Hole Dia.	D_1	1.55±0.20
Cover Tape Width	W_1	9.20
Cover Tape Thickness	d	0.065±0.02
Max. Component Rotation or Tilt		20° max
Devices Per Reel		2500
Reel Diameter		330 mm (13")

Footprint Drawing for PCB Layout



Note:
All dimensions are in mm.

Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (t_S) from (Tsmin to Tsmax)	60–120 seconds
Ramp-up Rate (t_L to t_P)	3°C/second max.
Liquidous Temperature (T_L)	217°C
Time (t_L) Maintained Above (T_L)	60–150 seconds
Peak Body Package Temperature	260°C +0°C / –5°C
Time (t_P) within 5°C of 260°C	30 seconds
Ramp-down Rate (T_P to T_L)	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

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SuperSOT™-6
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TinyPower™
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2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I61

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor:

FODM124 FODM124R2 FODM124R2V